

# STARPOWER

SEMICONDUCTOR

**IGBT**

## GD100HCX170C6S

**1700V/100A 4 in one-package**

### General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.

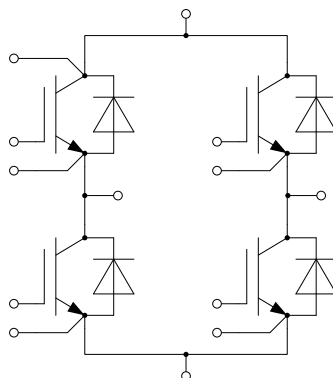
### Features

- Low  $V_{CE(sat)}$  Trench IGBT technology
- 10 $\mu$ s short circuit capability
- $V_{CE(sat)}$  with positive temperature coefficient
- Maximum junction temperature 175°C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology

### Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

### Equivalent Circuit Schematic



**Absolute Maximum Ratings**  $T_C=25^{\circ}\text{C}$  unless otherwise noted**IGBT**

| Symbol    | Description   | Value    | Unit |
|-----------|---|----------|------|
| $V_{CES}$ | Collector-Emitter Voltage                             | 1700     | V    |
| $V_{GES}$ | Gate-Emitter Voltage                                  | $\pm 20$ | V    |
| $I_C$     | Collector Current @ $T_C=25^{\circ}\text{C}$          | 169      | A    |
|           | @ $T_C=100^{\circ}\text{C}$                           | 100      | A    |
| $I_{CM}$  | Pulsed Collector Current $t_p=1\text{ms}$             | 200      | A    |
| $P_D$     | Maximum Power Dissipation @ $T_j=175^{\circ}\text{C}$ | 638      | W    |

**Diode**

| Symbol    | Description                                    | Value | Unit |
|-----------|--|-------|------|
| $V_{RRM}$ | Repetitive Peak Reverse Voltage                | 1700  | V    |
| $I_F$     | Diode Continuous Forward Current               | 100   | A    |
| $I_{FM}$  | Diode Maximum Forward Current $t_p=1\text{ms}$ | 200   | A    |

**Module**

| Symbol     | Description  | Value       | Unit               |
|------------|--|-------------|--------------------|
| $T_{jmax}$ | Maximum Junction Temperature                             | 175         | $^{\circ}\text{C}$ |
| $T_{jop}$  | Operating Junction Temperature                           | -40 to +150 | $^{\circ}\text{C}$ |
| $T_{STG}$  | Storage Temperature Range                                | -40 to +125 | $^{\circ}\text{C}$ |
| $V_{ISO}$  | Isolation Voltage RMS, $f=50\text{Hz}$ , $t=1\text{min}$ | 4000        | V                  |

**IGBT Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

| Symbol        | Parameter                               | Test Conditions  | Min.   | Typ. | Max. | Unit          |    |
|---------------|---|--|--|------|------|---------------|----|
| $V_{CE(sat)}$ | Collector to Emitter Saturation Voltage | $I_C=100\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$   |  | 1.85 | 2.20 | V             |    |
|               |   | $I_C=100\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$  |  | 2.25 |      |               |    |
|               |   | $I_C=100\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$  |  | 2.35 |      |               |    |
| $V_{GE(th)}$  | Gate-Emitter Threshold Voltage          | $I_C=4.00\text{mA}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$   | 5.6  | 6.2  | 6.8  | V             |    |
| $I_{CES}$     | Collector Cut-Off Current               | $V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$   |  |      | 5.0  | mA            |    |
| $I_{GES}$     | Gate-Emitter Leakage Current            | $V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$   |  |      | 400  | nA            |    |
| $R_{Gint}$    | Internal Gate Resistance                |  |  | 7.5  |      | $\Omega$      |    |
| $C_{ies}$     | Input Capacitance                       | $V_{CE}=25\text{V}, f=1\text{MHz}, V_{GE}=0\text{V}$   |  | 12.0 |      | nF            |    |
| $C_{res}$     | Reverse Transfer Capacitance            |  |  | 0.29 |      | nF            |    |
| $Q_G$         | Gate Charge                             | $V_{GE}=-15\dots+15\text{V}$   |  | 0.94 |      | $\mu\text{C}$ |    |
| $t_{d(on)}$   | Turn-On Delay Time                      | $V_{CC}=900\text{V}, I_C=100\text{A}, R_G=1.0\Omega, V_{GE}=\pm 15\text{V}, T_j=25^\circ\text{C}$  |  | 162  |      | ns            |    |
| $t_r$         | Rise Time                               |  |  | 38   |      | ns            |    |
| $t_{d(off)}$  | Turn-Off Delay Time                     |  |  | 357  |      | ns            |    |
| $t_f$         | Fall Time                               |  |  | 125  |      | ns            |    |
| $E_{on}$      | Turn-On Switching Loss                  |  |  | 28.6 |      | mJ            |    |
| $E_{off}$     | Turn-Off Switching Loss                 |  |  | 24.7 |      | mJ            |    |
| $t_{d(on)}$   | Turn-On Delay Time                      |  | $V_{CC}=900\text{V}, I_C=100\text{A}, R_G=1.0\Omega, V_{GE}=\pm 15\text{V}, T_j=125^\circ\text{C}$                 |      | 168  |               | ns |
| $t_r$         | Rise Time                               |  |  |      | 50   |               | ns |
| $t_{d(off)}$  | Turn-Off Delay Time                     |  |  | 470  |      | ns            |    |
| $t_f$         | Fall Time                               |  |  | 196  |      | ns            |    |
| $E_{on}$      | Turn-On Switching Loss                  |  |  | 38.3 |      | mJ            |    |
| $E_{off}$     | Turn-Off Switching Loss                 |  |  | 36.9 |      | mJ            |    |
| $t_{d(on)}$   | Turn-On Delay Time                      | $V_{CC}=900\text{V}, I_C=100\text{A}, R_G=1.0\Omega, V_{GE}=\pm 15\text{V}, T_j=150^\circ\text{C}$ |  |      | 168  |               | ns |
| $t_r$         | Rise Time                               |  |  |      | 50   |               | ns |
| $t_{d(off)}$  | Turn-Off Delay Time                     |  |  | 488  |      | ns            |    |
| $t_f$         | Fall Time                               |  |  | 216  |      | ns            |    |
| $E_{on}$      | Turn-On Switching Loss                  |  |  | 42.0 |      | mJ            |    |
| $E_{off}$     | Turn-Off Switching Loss                 |  |  | 39.4 |      | mJ            |    |
| $I_{SC}$      | SC Data                                 |  | $t_p \leq 10\mu\text{s}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}, V_{CC}=1000\text{V}, V_{CEM} \leq 1700\text{V}$ |      | 400  |               | A  |

**Diode Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

| Symbol    | Parameter                     | Test Conditions   | Min. | Typ. | Max. | Unit          |
|-----------|-------------------------------|---|------|------|------|---------------|
| $V_F$     | Diode Forward Voltage         | $I_F=100\text{A}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$   |      | 1.80 | 2.25 | V             |
|           |                               | $I_F=100\text{A}, V_{GE}=0\text{V}, T_j=125^\circ\text{C}$  |      | 1.90 |      |               |
|           |                               | $I_F=100\text{A}, V_{GE}=0\text{V}, T_j=150^\circ\text{C}$  |      | 1.95 |      |               |
| $Q_r$     | Recovered Charge              |   |      | 29.2 |      | $\mu\text{C}$ |
| $I_{RM}$  | Peak Reverse Recovery Current | $V_R=900\text{V}, I_F=100\text{A},$<br>$-di/dt=2400\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$<br>$T_j=25^\circ\text{C}$  |      | 132  |      | A             |
| $E_{rec}$ | Reverse Recovery Energy       |   |      | 15.0 |      | mJ            |
| $Q_r$     | Recovered Charge              |   |      | 47.9 |      | $\mu\text{C}$ |
| $I_{RM}$  | Peak Reverse Recovery Current | $V_R=900\text{V}, I_F=100\text{A},$<br>$-di/dt=2400\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$<br>$T_j=125^\circ\text{C}$ |      | 137  |      | A             |
| $E_{rec}$ | Reverse Recovery Energy       |   |      | 28.8 |      | mJ            |
| $Q_r$     | Recovered Charge              |   |      | 53.9 |      | $\mu\text{C}$ |
| $I_{RM}$  | Peak Reverse Recovery Current | $V_R=900\text{V}, I_F=100\text{A},$<br>$-di/dt=2400\text{A}/\mu\text{s}, V_{GE}=-15\text{V}$<br>$T_j=150^\circ\text{C}$ |      | 135  |      | A             |
| $E_{rec}$ | Reverse Recovery Energy       |   |      | 33.0 |      | mJ            |

**Module Characteristics**  $T_C=25^\circ\text{C}$  unless otherwise noted

| Symbol        | Parameter                                | Min. | Typ.  | Max.  | Unit       |
|---------------|--|------|-------|-------|------------|
| $L_{CE}$      | Stray Inductance                         |      | 20    |       | nH         |
| $R_{CC'+EE'}$ | Module Lead Resistance, Terminal to Chip |      | 1.10  |       | m $\Omega$ |
| $R_{thJC}$    | Junction-to-Case (per IGBT)              |      |       | 0.235 | K/W        |
|               | Junction-to-Case (per Diode)             |      |       | 0.437 |            |
| $R_{thCH}$    | Case-to-Heatsink (per IGBT)              |      | 0.055 |       | K/W        |
|               | Case-to-Heatsink (per Diode)             |      | 0.103 |       |            |
|               | Case-to-Heatsink (per Module)            |      | 0.009 |       |            |
| M             | Terminal Connection Torque, Screw M6     | 3.0  |       | 6.0   | N.m        |
|               | Mounting Torque, Screw M5                | 3.0  |       | 6.0   |            |
| G             | Weight of Module                         |      | 350   |       | g          |

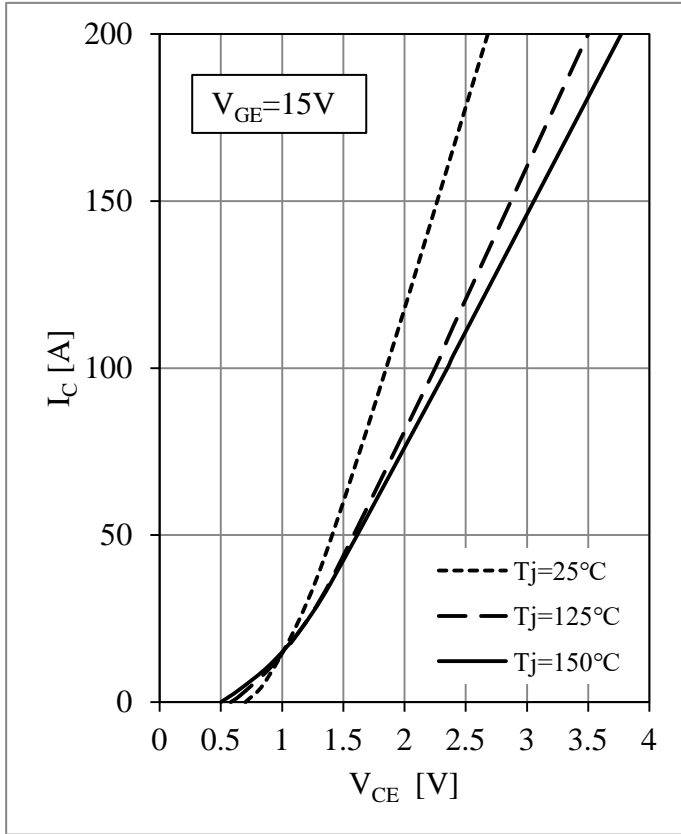


Fig 1. IGBT Output Characteristics

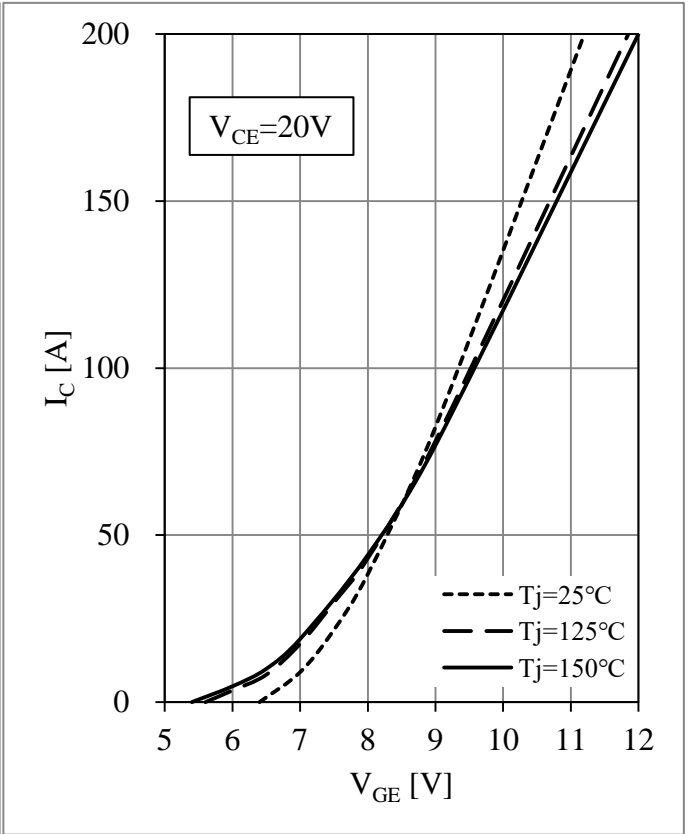


Fig 2. IGBT Transfer Characteristics

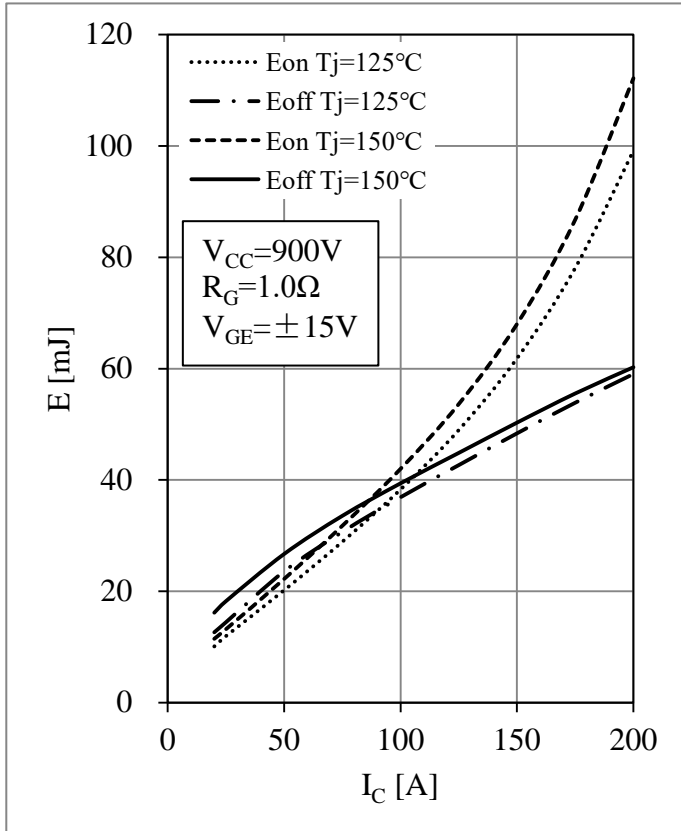


Fig 3. IGBT Switching Loss vs.  $I_C$

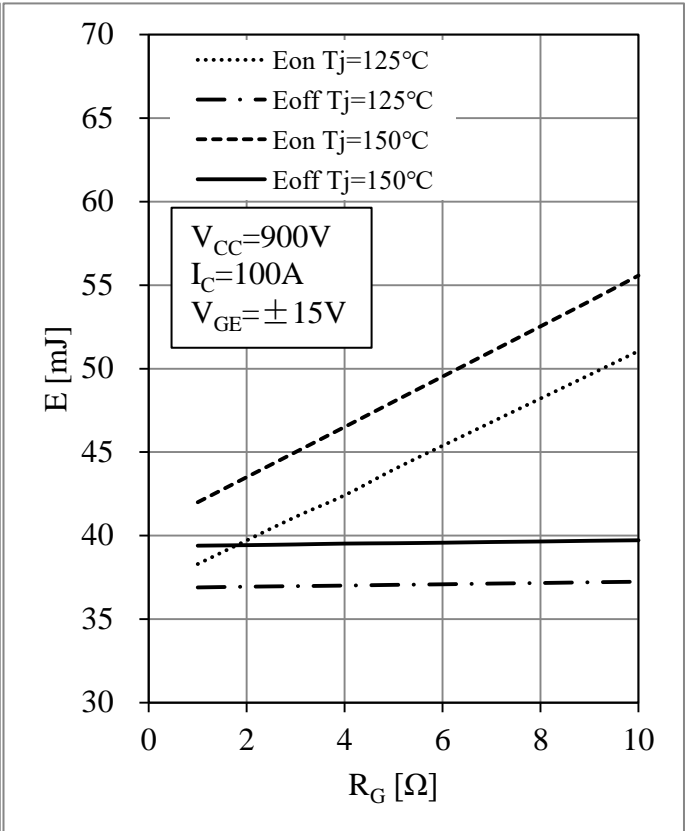


Fig 4. IGBT Switching Loss vs.  $R_G$

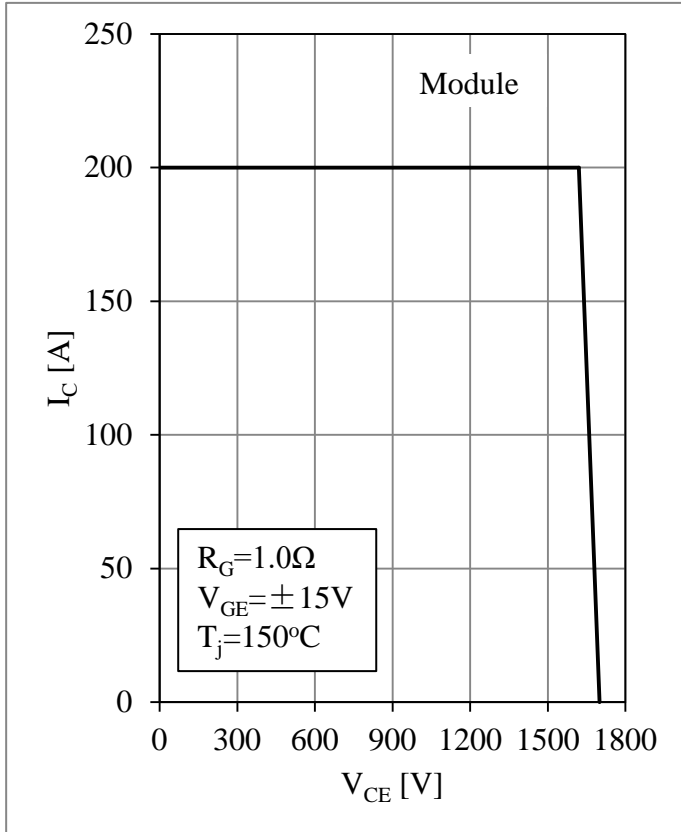


Fig 5. RBSOA

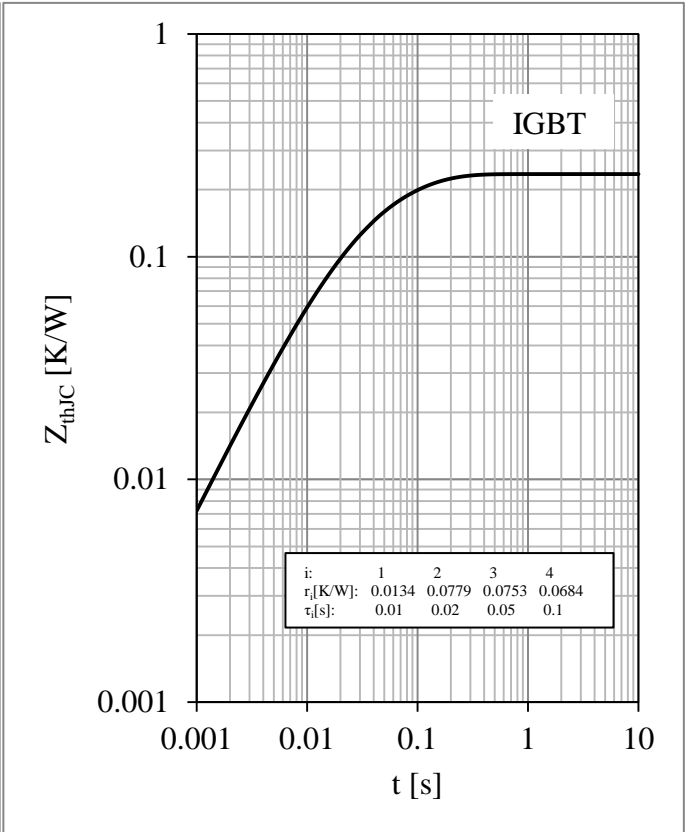


Fig 6. IGBT Transient Thermal Impedance

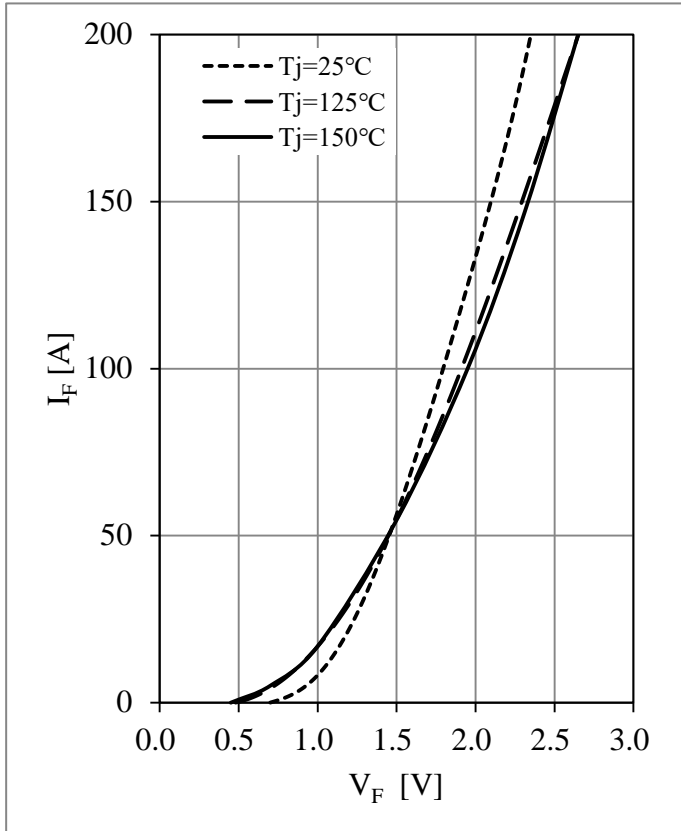


Fig 7. Diode Forward Characteristics

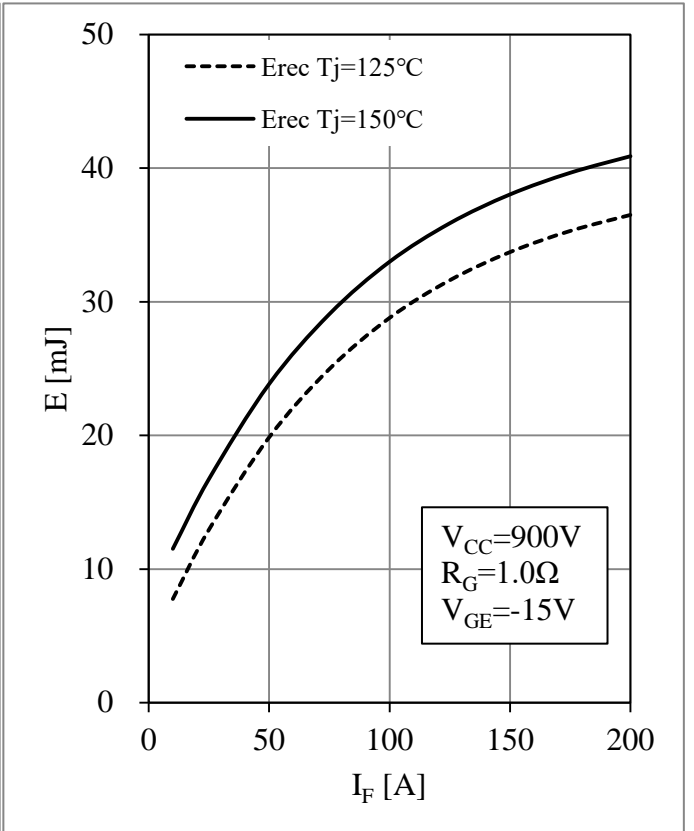


Fig 8. Diode Switching Loss vs.  $I_F$

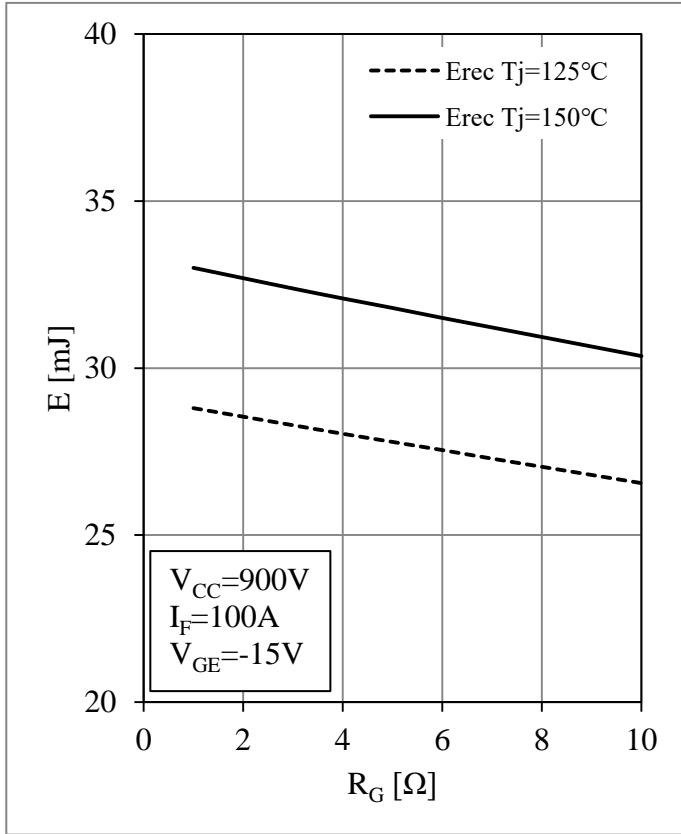


Fig 9. Diode Switching Loss vs.  $R_G$

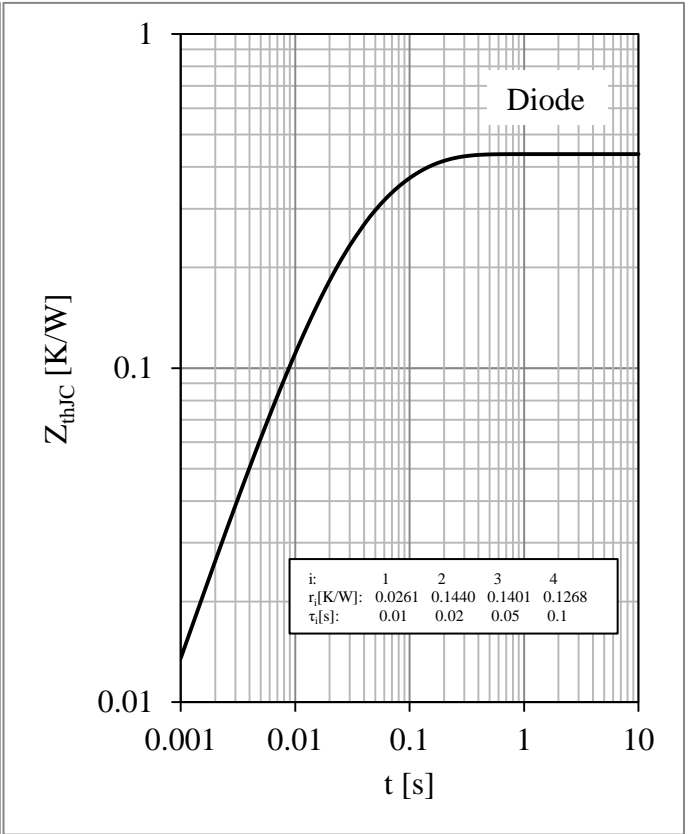
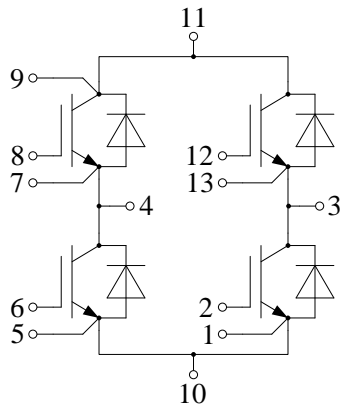


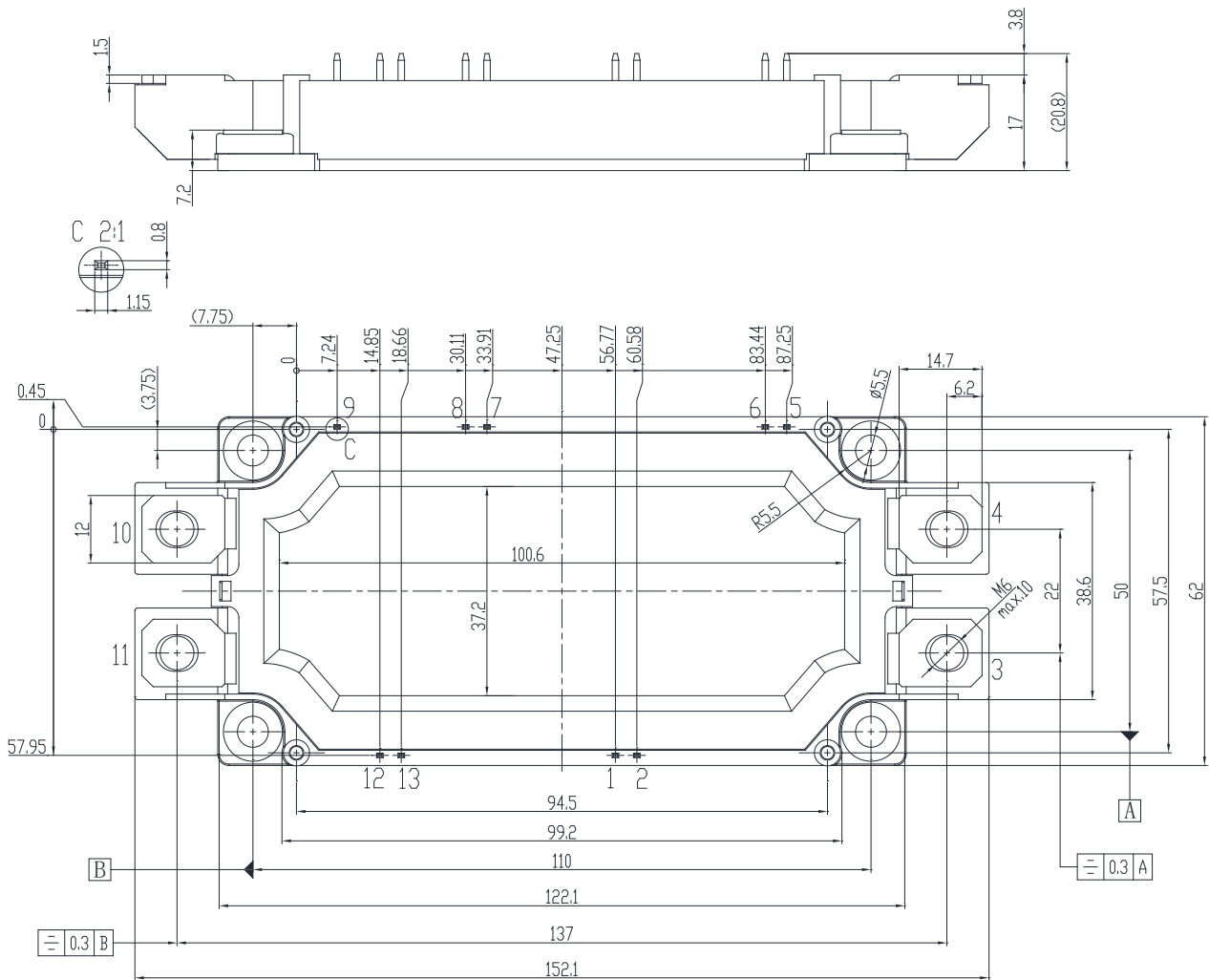
Fig 10. Diode Transient Thermal Impedance

**Circuit Schematic**



**Package Dimensions**

Dimensions in Millimeters





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